

# Vishay General Semiconductor

## **Surface-Mount Standard Rectifier**



### **LINKS TO ADDITIONAL RESOURCES**





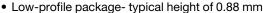






PRIMARY CHARACTERISTICS					
I <sub>F(AV)</sub> 2 A					
V <sub>RRM</sub>	200 V, 400 V, 600 V				
I <sub>FSM</sub>	32 A				
$V_F$ at $I_F = 2 \text{ A (T}_J = 125 °\text{C)}$	0.86 V				
T <sub>J</sub> max.	175 °C				
Package	DFN3820A				
Circuit configuration	Single				

#### **FEATURES**





 Leadless DFN package with side-wettable flanks suitable for customer AOI (Automatic Optical Inspection)



COMPLIANT HALOGEN

FREE

- Ideal for automated replacement
- Oxide planar chip junction
- Low forward voltage drop
- Typical IR less than 0.1 μA
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code: base P/NHM3
- Compatible to SMP (DO-220AA) package case outline
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

### TYPICAL APPLICATIONS

General purpose, power line polarity protection and rail-to-rail protection in consumer, industrial, and automotive applications.

### **MECHANICAL DATA**

Case: DFN3820A

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	SE20ND	SE20NG	SE20NJ	UNIT	
Device marking code		2D	2G	2J		
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	200	400	600	V	
Maximum average forward rectified current (fig.1)	I <sub>F(AV)</sub> (1)	2			A	
waximum average forward rectified current (fig.1)	I <sub>F(AV)</sub> (2)	1.5				
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	32			А	
Operating junction temperature range	T <sub>J</sub> <sup>(3)</sup>	-55 to +175		• °C		
Storage temperature range	T <sub>STG</sub>	-55 to +175			C	

### Notes

- (1) Mounted on 10 mm x 10 mm pad areas, 2 oz. FR4 PCB
- (2) Free air, mounted on recommended copper pad area
- (3) The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta,JA}$

# SE20ND, SE20NG, SE20NJ

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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 1 A	T <sub>J</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.91	-	V
	I <sub>F</sub> = 2 A			0.96	1.10	
	I <sub>F</sub> = 1 A	- T <sub>J</sub> = 125 °C		0.79	-	
	I <sub>F</sub> = 2 A			0.86	0.98	
Reverse current	Rated V <sub>R</sub>	T <sub>J</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	-	5	μΑ
	nated v <sub>R</sub>	T <sub>J</sub> = 125 °C		8	100	
Typical reverse recovery time	I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 01 A, I <sub>rr</sub> = 0.25 A		t <sub>rr</sub>	1200	-	ns
Typical junction capacitance	4.0 V, 1 MHz		СЈ	12	-	pF

### Notes

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

(2) Pulse test: pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise specified)							
PARAMETER	R SYMBOL TYP. MAX. UNIT						
Thermal resistance	R <sub>0JA</sub> (1)(2)	135	169	°C/W			
Thermal resistance	R <sub>0JM</sub> (3)	5	6.3	C/VV			

### **Notes**

- (1) The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$
- (2) Thermal resistance junction-to-ambient to follow JEDEC® 51-2A, device mounted on FR4 PCB, 2 oz., standard footprint
- (3) Thermal resistance junction-to-mount to follow JEDEC 51-14 transient dual interface test method (TDIM)

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS ( $T_A = 25~^{\circ}\text{C}$ unless otherwise noted)						
STANDARD TEST TYPE TEST CONDITIONS SYMBOL CLASS VALUE						
AEC-Q101-001	Human body model (contact mode)	$C = 100 \text{ pF}, R = 1.5 \text{ k}\Omega$		H3B	> 8 kV	
AEC-Q101-002	Machine model (contact mode)	$C = 200 \text{ pF}, R = 0 \Omega$		M4	> 400 V	
JESD22-A114	Human body model (contact mode)	$C = 100 \text{ pF}, R = 1.5 \text{ k}\Omega$	V	3B	> 8 kV	
JESD22-A115	Machine model (contact mode)	$C = 200 \text{ pF}, R = 0 \Omega$	$V_{C}$	С	> 400 V	
IEC 61000-4-2 (2)	Human body model (contact mode)	$C = 150 \text{ pF}, R = 330 \Omega$		4	> 8 kV	
IEC 01000-4-2 (=)	Human body model (air-discharge mode) (1)	C = 150 pF, R = 330 $\Omega$		4	> 15 kV	

### Notes

(1) Immunity to IEC 61000-4-2 air discharge mode has a typical performance > 30 kV

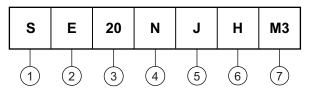
<sup>(2)</sup> System ESD standard

# SE20ND, SE20NG, SE20NJ

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### **ORDERING INFORMATION TABLE**

**Device code** 



1 - Vishay standard recovery product

Oxide planar chip technology

3 - Current rating (20 = 2A)

Package type (N = DFN package)

5 - Voltage rating (D = 200 V, G = 400 V, J = 600 V)

- Quality grade (H = AEC-Q101 qualified, otherwise = industry grade)

 Material / Environment category (M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free)

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
SE20NJ-M3/H	0.023	Н	3500	7" diameter plastic tape and reel		
SE20NJ-M3/I	0.023	I	14 000	13" diameter plastic tape and reel		
SE20NJHM3/H (1)	0.023	Н	3500	7" diameter plastic tape and reel		
SE20NJHM3/I (1)	0.023	I	14 000	13" diameter plastic tape and reel		

#### Note

(1) AEC-Q101 qualified

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### **RATINGS AND CHARACTERISTICS CURVES** (T<sub>A</sub> = 25 °C unless otherwise noted)

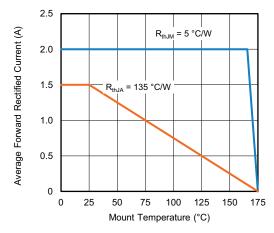


Fig. 1 - Maximum Forward Current Derating Curve

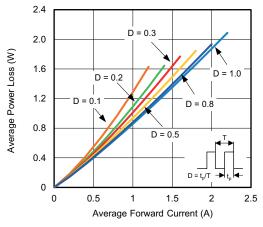


Fig. 2 - Forward Power Loss Characteristics

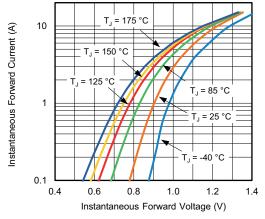


Fig. 3 - Typical Instantaneous Forward Characteristics

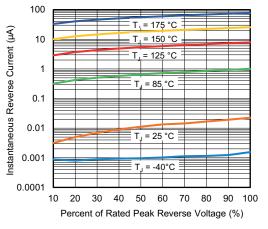


Fig. 4 - Typical Reverse Leakage Characteristics

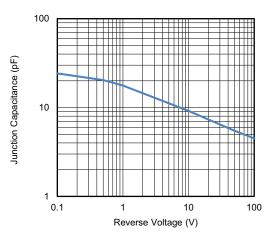


Fig. 5 - Typical Junction Capacitance

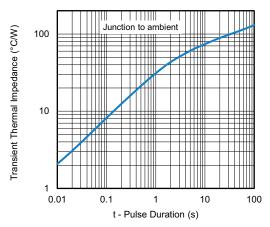


Fig. 6 - Typical Transient Thermal Impedance

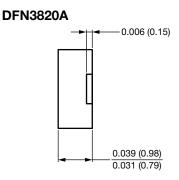


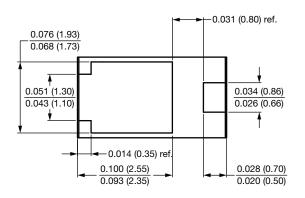


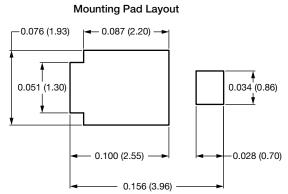
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### PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

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Vishay

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